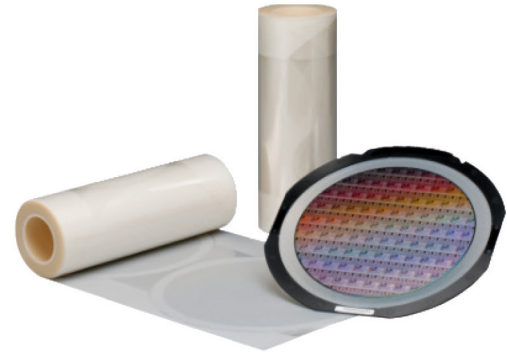


## LD series

LD series is Adwill's dicing die-bonding tape which is best suited for DBG (Dicing Before Grinding) processes. Highly precise separation of the die-attach layer is achieved by full-cut laser dicing and subsequent grinding.

- Easy pick-up for ultra-thin dies
- Suitable for high density and multi-stacked packages

## Dicing Die-Bonding Tape



| Application                  | Dicing Method | LD-Layer Thickness | Type        | Tape Name |
|------------------------------|---------------|--------------------|-------------|-----------|
| DBG (Dicing Before Grinding) | Laser         | 7 $\mu\text{m}$    | Heat curing | LD01D-7   |